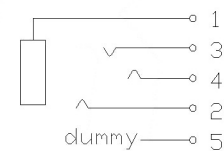
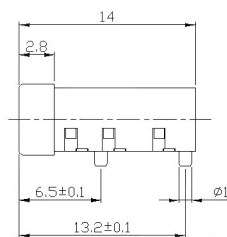
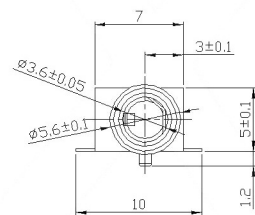
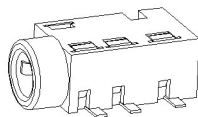


PCB LAYOUT



CIRCUIT DIAGRAM



	MATERIAL	PLATING
terminal 1	copper all oy	silver
terminal 2	copper all oy	silver
terminal 3	copper all oy	silver
terminal 4	copper all oy	silver
plastic	PA10T	

DSND		DATE	SCALE: N/A	MODEL TYPE: 3.5 PHONE JACK
DWN		DATE	VIEW:	PART NO.:
CHKD		DATE	UNIT: mm	DWG NO.:
APPD		DATE	SIZE: A4	PJ-327E-SMT
KOSOD TECHNOLOGY CO., LTD				WEIGHT 1.0g
				SHEET 1/1
				REVISION A0

					ANGULAR	±5°
△X					L ≤ 4	±0.2
△X					4 < L ≤ 16	±0.3
△X					16 < L ≤ 63	±0.4
MARK					L > 63	±0.5
REVISIONS						UNSPECIFIED TOLERANCES
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